AUTOMOTIVE

HALOGEN FREE



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## Vishay General Semiconductor

# High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.61 \text{ V}$  at  $I_F = 5 \text{ A}$ 



#### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	20 A			
$V_{RRM}$	150 V			
I <sub>FSM</sub>	150 A			
$V_F$ at $I_F = 10$ A ( $T_A = 125$ °C)	0.69 V			
T <sub>J</sub> max.	175 °C			
Package	SlimDPAK (TO-252AE)			
Circuit configuration Common cathode				

#### **FEATURES**

- Very low profile typical height of 1.3 mm
- Trench MOS Schottky technology
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

## **MECHANICAL DATA**

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER		SYMBOL	V20PWM15C	UNIT
Device marking code			V20PWM15C	
Maximum repetitive peak reverse voltage		V <sub>RRM</sub> 150		V
Maximum average forward rectified current (Fig. 1)	per device	I <sub>F(AV)</sub> <sup>(1)</sup>	20	А
	per diode		10	А
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode		I <sub>FSM</sub>	150	А
Operating junction temperature range		T <sub>J</sub> <sup>(2)</sup>	-40 to +175	°C
Storage temperature range		T <sub>STG</sub>	-55 to +175	°C

### Notes

(1) With infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$ 

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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage per diode	I <sub>F</sub> = 5.0 A	T 05 %0		0.81	-	
	I <sub>F</sub> = 10 A	V <sub>E</sub> (1)	1.16	1.24	V	
	I <sub>F</sub> = 5.0 A	T <sub>A</sub> = 125 °C	V <sub>F</sub> ('')	0.61	-	V
	I <sub>F</sub> = 10 A			0.69	0.75	
Reverse current per diode	V = 100 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	0.01	-	mA
	V <sub>R</sub> = 100 V	T <sub>A</sub> = 125 °C		1.5	-	
Reverse current per diode	V <sub>R</sub> = 150 V	T <sub>A</sub> = 25 °C		-	0.15	
		T <sub>A</sub> = 125 °C		3	10	
Typical junction capacitance	4.0 V, 1 MHz	•	CJ	560	-	pF

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	V20PWM15C	UNIT		
Typical thermal resistance	R <sub>0</sub> JA (1)(2)	55	°C/W		
	R <sub>0JM</sub> (3)	1.8			

#### Notes

(1) The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

 $^{(2)}$  Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

 $^{(3)}$  Mounted on infinite heat sink; thermal resistance  $R_{\theta JM}$  - junction-to-mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	RRED P/N UNIT WEIGHT (g) PREFERRED PACKAGE CODE BASE Q		BASE QUANTITY	DELIVERY MODE	
V20PWM15C-M3/I	0.20	I	4500	13" diameter plastic tape and reel	
V20PWM15CHM3/I (1)	0.20	I	4500	13" diameter plastic tape and reel	

#### Note

(1) AEC-Q101 qualified

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## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

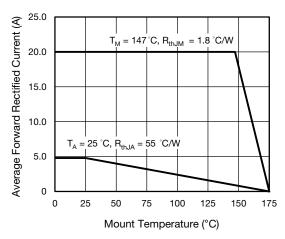


Fig. 1 - Maximum Forward Current Derating Curve

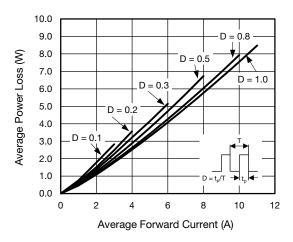


Fig. 2 - Forward Power Loss Characteristics

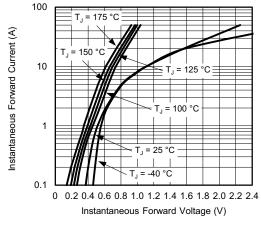


Fig. 3 - Typical Instantaneous Forward Characteristics

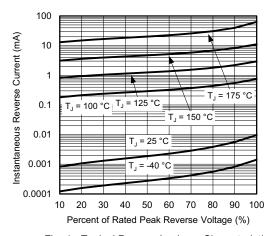


Fig. 4 - Typical Reverse Leakage Characteristics

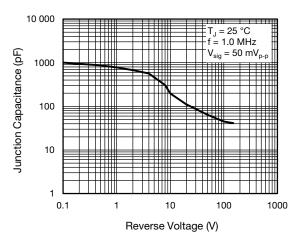


Fig. 5 - Typical Junction Capacitance

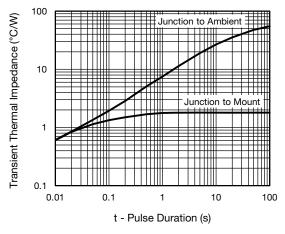


Fig. 6 - Typical Transient Thermal Impedance

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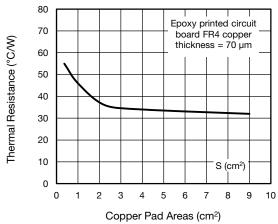
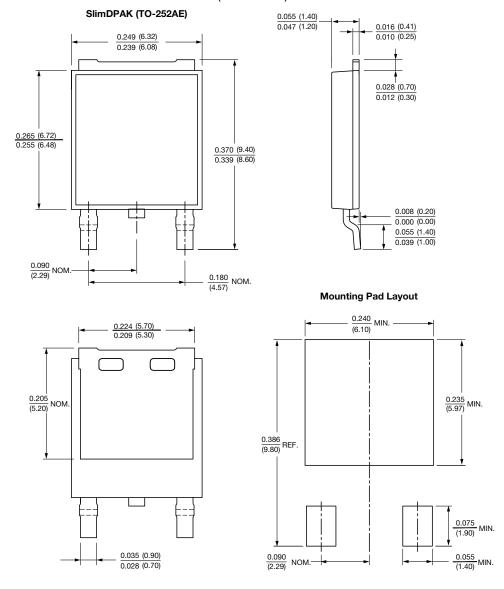


Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)



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